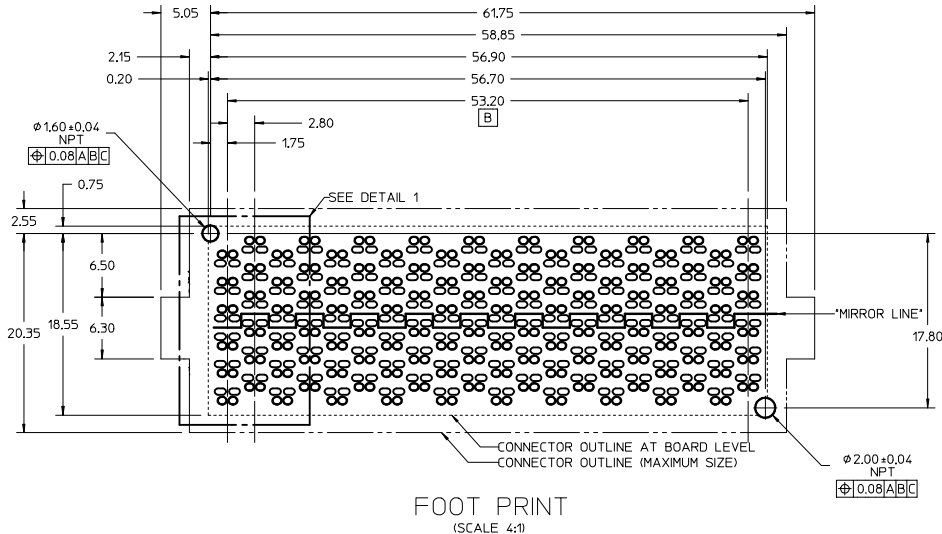
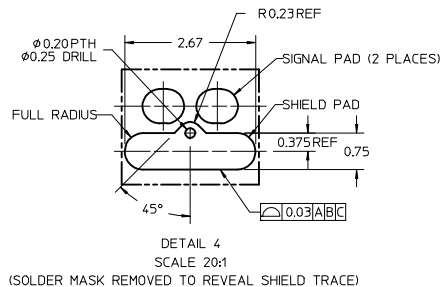
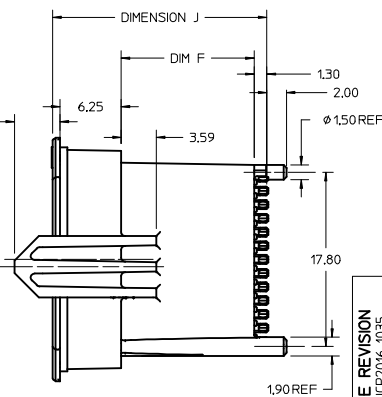
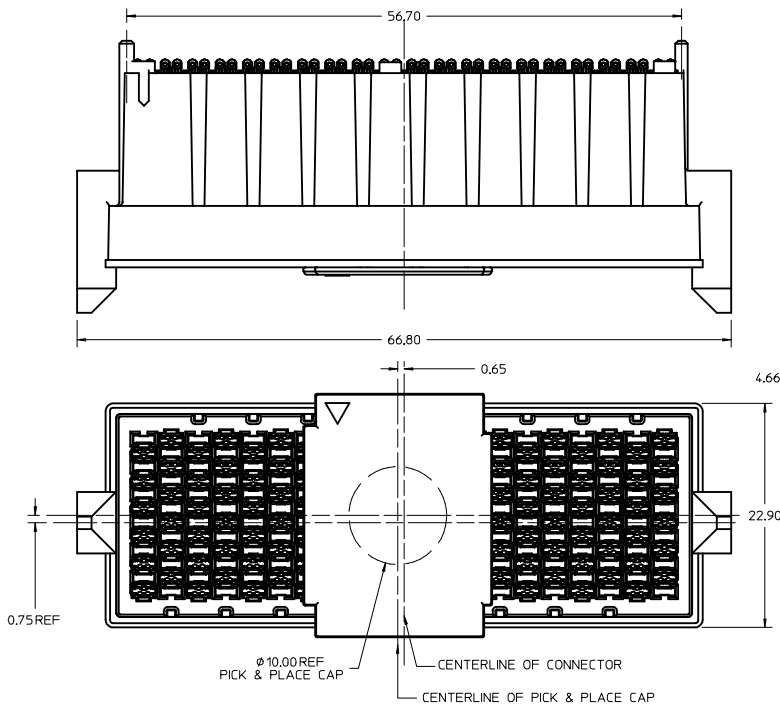
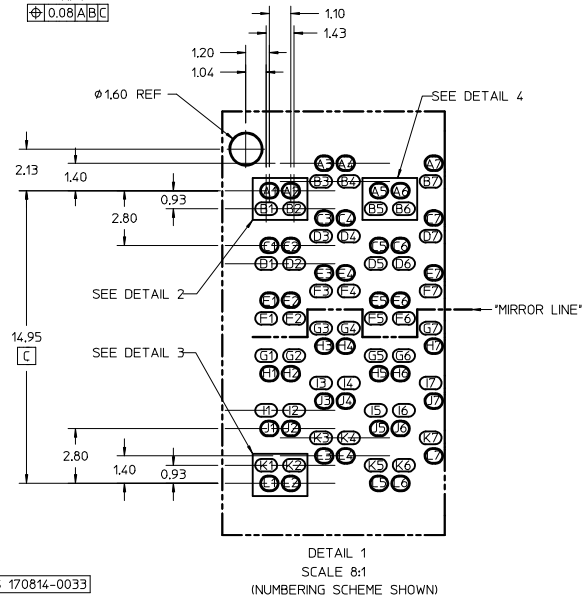
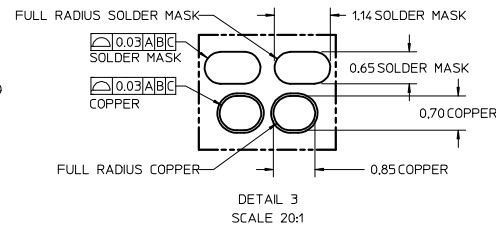
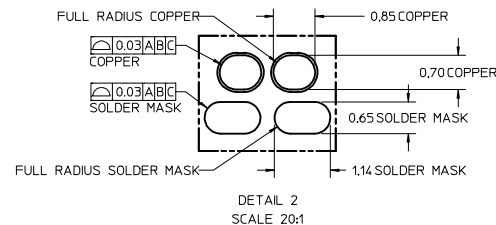


- NOTES:
- HOUSING MATERIAL: LCP, GLASS FILLED, UL 94V-0, BLACK
CONTACT MATERIAL: HIGH PERFORMANCE COPPER ALLOY
SOLDER CHARGE: LEAD FREE SOLDER ALLOY
 - FINISH:
CONTACTS: SELECTIVE GOLD: 30 MICHES MIN ON CONTACT AREA.
SELECTIVE TIN: 100 MICHES MIN ON SOLDERABLE PORTION
OF SOLDER TAILS, OVER 50 MICHES MIN NICKEL OVERALL.
 - PRODUCT SPECIFICATION: PS-170807-0001
 - PACKAGING SPECIFICATION: PK-170814-002
 - APPLICATION SPECIFICATION: AS-170807-0001



- FOOT PRINT NOTES:
- DATUM -A- IS THE TOP OF THE PCB.
 - ALL DIMENSIONS ARE BASICS.
 - ROW A, C, E, H, J AND L PADS (SIGNAL PADS) ARE COPPER DEFINED.
 - ROW B, D, F, G, I AND K PADS (SHIELD PADS) ARE SOLDER MASK DEFINED.



PART ILLUSTRATED IS 170814-0033

UPDATE REVISION		QUALITY SYMBOLS		GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE		DESIGN UNITS		THIRD ANGLE PROJECTION	
IEC NO: UCP2016-1035		▽=0		mm INCH		MM ONLY		4:1		METRIC		⊙ □ THIRD ANGLE PROJECTION	
2015/09/10		▽=0		4 PLACES ±		DRAWN BY DATE		TITLE		RECEPTACLE			
DRW:SKANG		▽=0		3 PLACES ±		KPELOZA 2010/11/19				6X20			
2015/09/30		▽=0		2 PLACES ±		CHECKED BY DATE				NEOSCALE			
CHYO-JESSIECHIA				± 0.15		KPELOZA 2010/11/19				molex			
2015/09/30				1 PLACE ±		APPROVED BY DATE							
APPR:SHONG				0 PLACE ±		JCOMERCI 2010/11/19							
				ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.				SHEET NO.	
				DRAFT WHERE APPLICABLE		SEE CHART		SD-170814-0005				1 OF 2	
A				MUST REMAIN WITHIN DIMENSIONS		SIZE D		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

[illegible]